



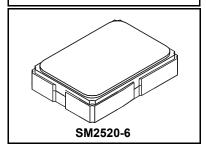
### SF1186G-6

- · RF filter designed for front end GPS applications
- · Low Insertion Loss
- 2.0 x 2.5 x 0.75 mm Surface Mount Case
- Complies with Directive 2002/95/EC (RoHS)
- Moisture Sensitivity Level: 1
- AEC-Q200 Qualified

#### **Absolute Maximum Ratings**

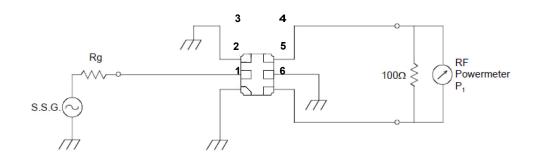
Rating	Value	Units
Input Power Level	+17	dBm
DC Voltage	3	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C

### 1575.5 MHz **SAW Filter**



#### **Electrical Characteristics**

Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	F <sub>C</sub>			1575.42		MHz
Insertion Loss, 1574 to 1577 MHz	IL			1.5	1.9	dB
Amplitude Ripple, 1574 to 1577 MHz				0.2	0.5	uБ
VSWR, 1574 to 1577 MHz				1.5	1.8	
Amplitude Balance 1574 to 1577 MHz			-1.6	±1.3	+1.6	dB
Phase Balance 1574 to 1577 MHz			170	180±4	190	deg
Attenuation Referenced to 0 dB:						
100 to 1475 MHz			30	47		
1475 to 1525 MHz			15	33		dB
1625 to 1675 MHz			9	22		ав
1675 to 3000 MHz			30	33		
3000 to 6000 MHz			25	30		
Case Style			SM2520-6	Nominal Footpri	nt	
Lid Symbolization (Y=year, WW=week, S=shift) dot = pin 1 indicator	5A, <u>YWWS</u>					
Standard Reel Quantity Reel Size 7 Inch	2.000 Pieces/Reel					



Reel Size 13 Inch

Connection	Terminals
Input	2
Output	4, 6
Ground	All Others

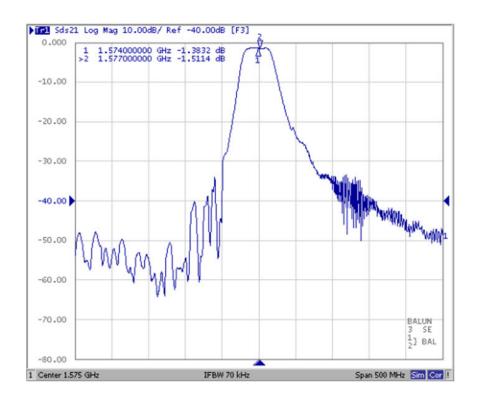
10,000 Pieces/Reel

### CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

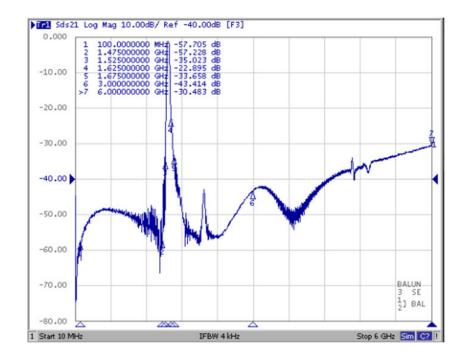
- 1. The design, manufacturing process, and specifications of this device are subject to change.
- 2. US or International patents may apply.
- 3. RoHS compliant from the first date of manufacture.

### **Frequency Characteristics**

### S21 Response (span 500 MHz)

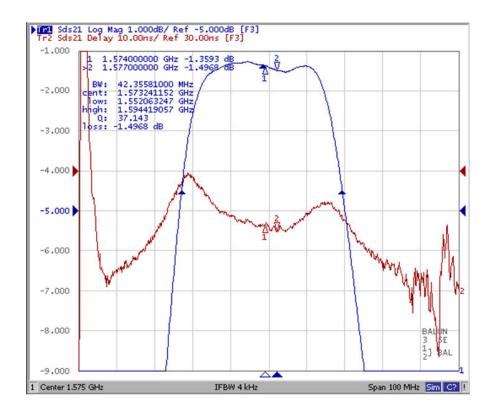


### S21 Response (span 6 GHz)

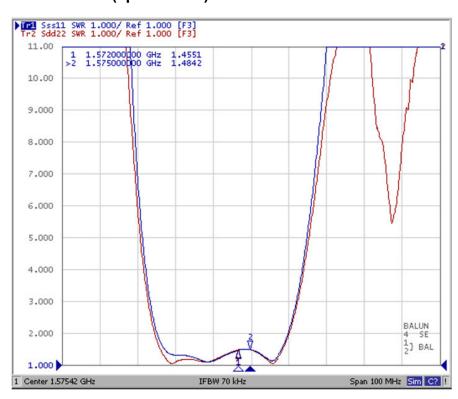


### **Frequency Characteristics (continued)**

### S21 Response (span 100 MHz)



### S11 and S22 VSWR (span 6 GHz)



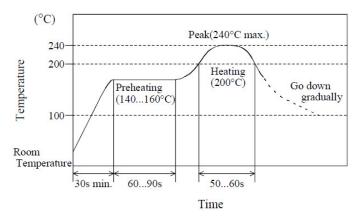
## **Physical and Environmental Characteristics**

Test Item	Test Condition	Criteria
PCB Bend Strength	Filter is soldered onto the center of 0.8mm thickness PCB which is laid on the two small supporters spaced 90mm as shown in below figure. PCB is deflected to 2mm below from horizontal level by the pressing stick. The force is supplied for 1 second - 5 times repeatedly.  Pressing Stick  Unit:mm  PCB  At 10  PCB  At 10	No visible damage should be induced.
Vibration	The electrical performance is measured after being applied vibration of amplitude of 1.5mm with 10 to 55Hz of vibration frequency to each of 3 perpendicular directions for 2 hours.	
Drop Test	The electrical performance is measured after dropping with housing (around 100g) from a height of 150cm onto the concrete plate 3 times in each of 6 perpendicular directions.	
Solderability	Terminals are immersed in rosin flux (concentration 2025%, solvent: ethanol 7580%) for 5 seconds, then immersed in soldering bath at 230±5°C (solder: JIS-Z-3282 H63A, H60A or Sn-3.0Ag-0.5Cu) for 5±0.5 seconds.	90% minimum of the immersed surface should be covered with solder.
Resistance to Soldering Heat	Filter is preheated at 170±10°C for 90 seconds, immersed whole electrode in soldering bath at 255±5°C for 3±1seconds, then measured after being placed in standard atmospheric conditions for 2 hours.	
Humidity	The electrical performance is measured after being placed in a chamber with 9095% R.H. at 60°C for 500 hours and then being placed in standard atmospheric conditions for 2 hours.	
Life Test (High Temperature)	The electrical performance is measured after being placed in a chamber with 85°C for 500 hours and then being placed in standard atmospheric conditions for 2 hours.	
Life Test (Low Temperature)	The electrical performance is measured after being placed in a chamber with -40°C for 500 hours and then being placed in standard atmospheric conditions for 2 hours.	
Thermal Shock	After temperature cycling of -55°C for 30 minutes to +85°C for 30 minutes performed 100 times, filter shall be returned to room temperature. And the electrical performance is measured after being placed in standard atmospheric conditions for 2 hours.	
Resistance to Reflow Soldering	The electrical performance is measured after being soldered by reflow 2 times with the following reflow profile A or B and then being placed in standard atmospheric conditions for 24 hours.	

### **Reflow Profile**

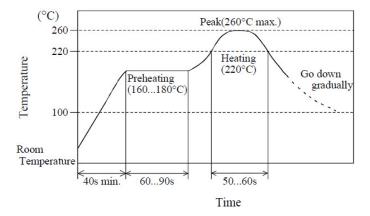
### **Profile A**

- Preheating shall be fixed at 140...160°C for 60...90 seconds. Ascending time to preheating temperature 150°C shall be 30 seconds minimum. Heating shall be fixed at 200°C for 50...60 seconds and at 230±10°C peak.



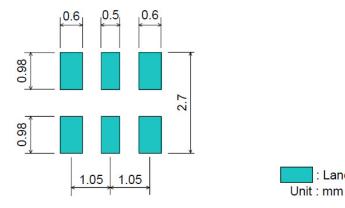
### **Profile B**

- Preheating shall be fixed at 160...180°C for 60...90 seconds. Ascending time to preheating temperature 170°C shall be 40 seconds minimum. Heating shall be fixed at 220°C for 50...60 seconds and at 255 $\pm$ 5°C peak.
- 2. 3.



### **Recommended Land Pattern**

Recommended land pattern is as follows.

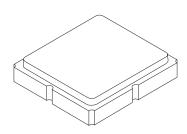


: Land Pattern

## **SM2520-6 Case**

# 6-Terminal Ceramic Surface-Mount Case 2.5 X 2.0 mm Nominal Footprint

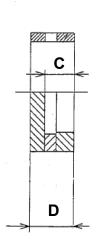




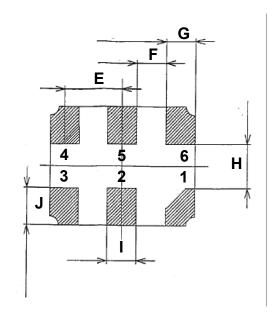
		•				
Dimension	mm			Inches		
Dilliension	Min	Nom	Max	Min	Nom	Max
Α	-	2.00	-	-	0.078	-
В	-	2.50	-	-	0.098	-
С	-	0.50	-	-	0.029	-
D	-	0.75	-	-	0.019	-
E	-	1.00	-	-	0.039	-
F	-	0.50	-	-	0.019	-
G	-	0.50	-	-	0.019	-
Н	-	0.74	-	-	0.029	-
I	-	0.50	-	-	0.019	-
J	-	0.63	-	-	0.024	-

**TOP VIEW** 

B
6 5 4
A 5A
YWWS
1 2 3

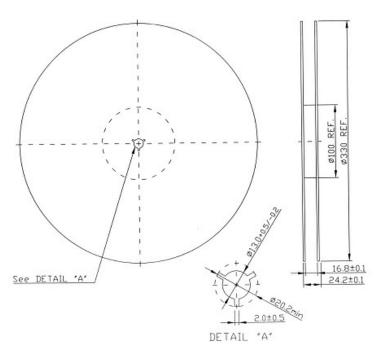


### **BOTTOM VIEW**



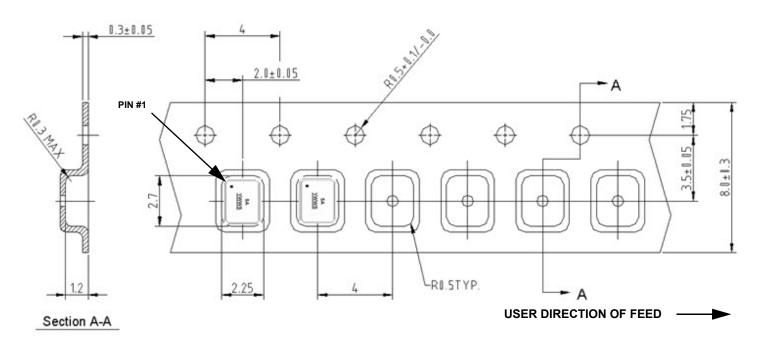
### **Tape and Reel Specifications**

Tape and Reel Standard per ANSI/EIA-481



4	'B"	Quantity Per Reel		
Inches	millimeters			
7	178	2000		
13	330	10000		

### **COMPONENT ORIENTATION and DIMENSIONS**



### **Recommended Reflow Profile**

- 1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
- 2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
- 3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C+0/-5°C peak (10 seconds).
- 4. Time: 5 times maximum.

